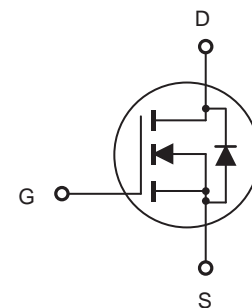


- 20V, 4.5A,  $R_{DS(ON)} = 33m\Omega$  @  $V_{GS} = 4.5V$ .  
 $R_{DS(ON)} = 40m\Omega$  @  $V_{GS} = 2.5V$ .
- High dense cell design for extremely low  $R_{DS(ON)}$ .
- Rugged and reliable.
- Lead free product is acquired.
- SOT-23 package.



## ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ C$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 8$	V
Drain Current-Continuous	$I_D$	4.5	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$	13.5	A
Maximum Power Dissipation	$P_D$	1.25	W
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 150	$^\circ C$

## Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Ambient <sup>b</sup>	$R_{\theta JA}$	100	$^\circ C/W$

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units	
<b>Off Characteristics</b>							
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20			V	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 20V, V_{GS} = 0V$			1	$\mu A$	
Gate Body Leakage Current, Forward	$I_{GSSF}$	$V_{GS} = 8V, V_{DS} = 0V$			100	nA	
Gate Body Leakage Current, Reverse	$I_{GSSR}$	$V_{GS} = -8V, V_{DS} = 0V$			-100	nA	
<b>On Characteristics</b> <sup>c</sup>							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}, I_D = 250\mu A$	0.5		1.2	V	
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 5.0A$		27	33	$m\Omega$	
		$V_{GS} = 2.5V, I_D = 4.5A$		33	40	$m\Omega$	
Forward Transconductance	$g_{FS}$	$V_{DS} = 10V, I_D = 5.0A$		10		S	
<b>Dynamic Characteristics</b> <sup>d</sup>							
Input Capacitance	$C_{iss}$	$V_{DS} = 8V, V_{GS} = 0V,$ $f = 1.0\text{ MHz}$		500		pF	
Output Capacitance	$C_{oss}$				300		pF
Reverse Transfer Capacitance	$C_{rss}$				140		pF
<b>Switching Characteristics</b> <sup>d</sup>							
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 10V, I_D = 1A, \square$ $V_{GS} = 4.5V, R_{GEN} = 6\Omega$		20	40	ns	
Turn-On Rise Time	$t_r$				18	40	ns
Turn-Off Delay Time	$t_{d(off)}$				60	108	ns
Turn-Off Fall Time	$t_f$				28	56	ns
Total Gate Charge	$Q_g$	$V_{DS} = 10V, I_D = 5.0A,$ $V_{GS} = 4.5V$		10	15	nC	
Gate-Source Charge	$Q_{gs}$				2.3		nC
Gate-Drain Charge	$Q_{gd}$				2.9		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>							
Drain-Source Diode Forward Current <sup>b</sup>	$I_S$				1.0	A	
Drain-Source Diode Forward Voltage <sup>c</sup>	$V_{SD}$	$V_{GS} = 0V, I_S = 1A$			1.2	V	
<b>Notes :</b> a.Repetitive Rating : Pulse width limited by maximum junction temperature. b.Surface Mounted on FR4 Board, $t \leq 10$ sec. c.Pulse Test : Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ . d.Guaranteed by design, not subject to production testing.							